# 2SD1535

## Silicon NPN triple diffusion planar type darlington

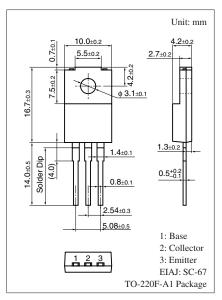
### For high power amplification

#### ■ Features

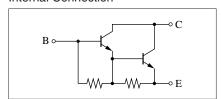
- $\bullet$  Excellent collector current  $I_C$  characteristics of forward current transfer ratio  $h_{FE}$
- High collector-base voltage (Emitter open) V<sub>CBO</sub>
- Wide safe operation area
- Full-pack package which can be installed to the heat sink with one screw

### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)		V <sub>CBO</sub>	500	V
Collector-emitter voltage (Base open)		V <sub>CEO</sub>	400	V
Emitter-base voltage (Collector open)		$V_{EBO}$	12	V
Collector current		$I_C$	7	A
Peak collector current		$I_{CP}$	14	A
Base current		$I_B$	0.5	A
Collector power		P <sub>C</sub>	50	W
dissipation	$T_a = 25$ °C		2.0	
Junction temperature		T <sub>j</sub>	150	°C
Storage temperature	$T_{stg}$	-55 to +150	°C	



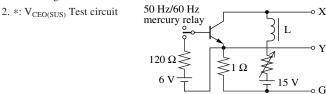
#### Internal Connection

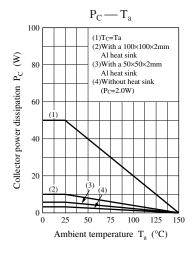


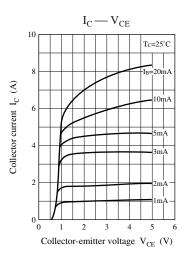
## ■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

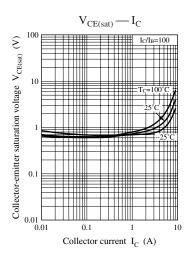
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter sustaining voltage *	V <sub>CEO(SUS)</sub>	$I_C = 100 \text{ mA}, R_{BE} = \infty, L = 25 \text{ mH}$	400			V
Collector-base cutoff current (Emitter open)	$I_{CBO}$	$V_{CB} = 500 \text{ V}, I_E = 0$			100	μΑ
Collector-emitter cutoff current (Base open)	$I_{CEO}$	$V_{CE} = 400 \text{ V}, I_{B} = 0$			100	μΑ
Emitter-base cutoff current (Collector open)	$I_{EBO}$	$V_{EB} = 12 \text{ V}, I_C = 0$			100	mA
Forward current transfer ratio	h <sub>FE1</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 2 \text{ A}$	500			_
	h <sub>FE2</sub>	$V_{CE} = 2 \text{ V}, I_{C} = 6 \text{ A}$	200			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 7 \text{ A}, I_B = 70 \text{ mA}$			2.0	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_C = 7 \text{ A}, I_B = 70 \text{ mA}$			2.5	V
Transition frequency	$f_T$	$V_{CE} = 10 \text{ V}, I_{C} = 0.5 \text{ A}, f = 1 \text{ MHz}$		20		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		70		pF
(Common base, input open circuited)						
Turn-on time	t <sub>on</sub>	$I_C = 7 \text{ A}, I_{B1} = 70 \text{ mA}, I_{B2} = -70 \text{ mA},$		1.5		μs
Storage time	t <sub>stg</sub>	$V_{CC} = 300 \text{ V}$		5.0		μs
Fall time	$t_{\rm f}$			6.5		μs

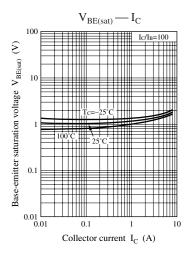
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

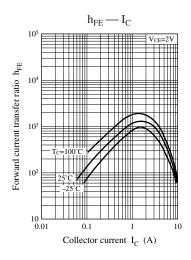


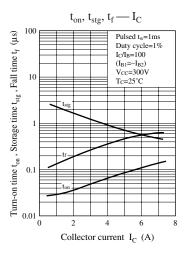


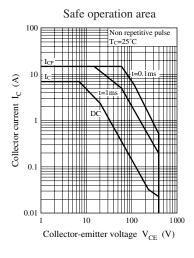


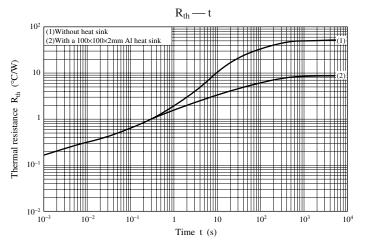












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